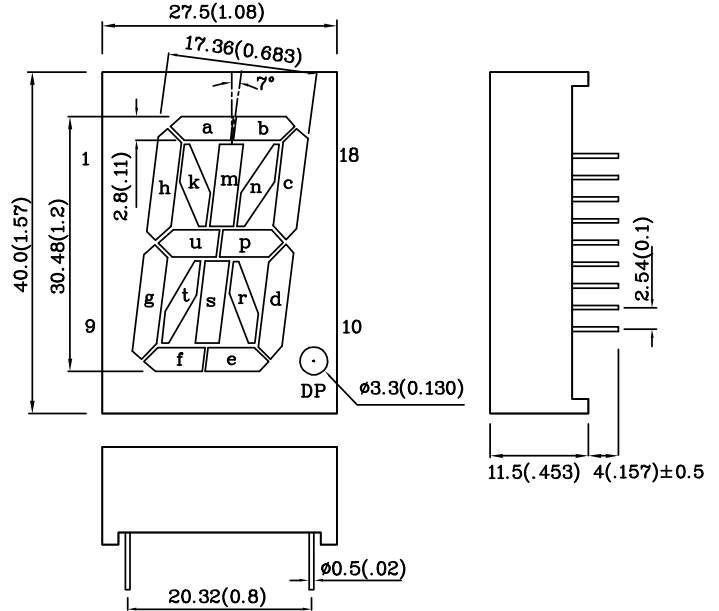
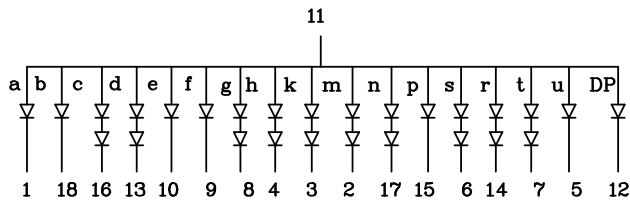


Features

- 1.2 INCH CHARACTER HEIGHT.
- LOW CURRENT OPERATION.
- HIGH CONTRAST AND LIGHT OUTPUT.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- CATEGORIZED FOR LUMINOUS INTENSITY.
- MECHANICALLY RUGGED.
- STANDARD : GRAY FACE, WHITE SEGMENT.
- RoHS COMPLIANT.



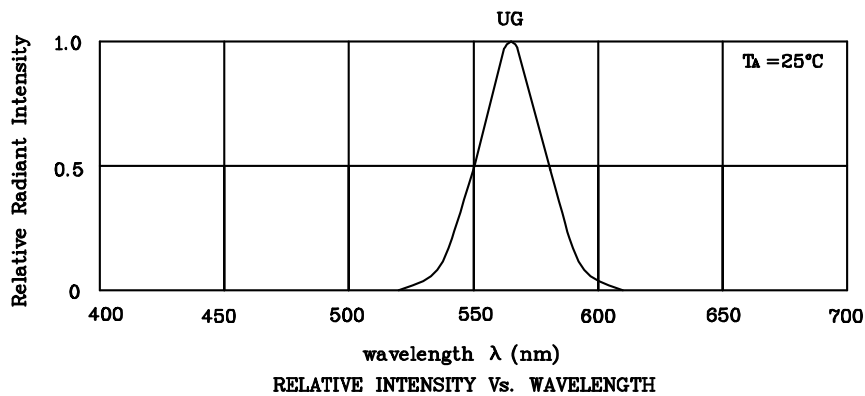
Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25(0.01)$ " unless otherwise noted.

Absolute maximum ratings ($T_A=25^\circ\text{C}$)			UG (GaP)	Unit
Reverse Voltage	C,D,G,H,K,M,N,S,R,T	V_R	10	V
	A,B,E,F,P,U(DP)		5	
DC Forward Current	C,D,G,H,K,M,N,S,R,T	I_F	25	mA
	A,B,E,F,P,U(DP)			
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	C,D,G,H,K,M,N,S,R,T	i_{FS}	140	mA
	A,B,E,F,P,U(DP)			
Power Dissipation	C,D,G,H,K,M,N,S,R,T	P_T	125	mW
	A,B,E,F,P,U(DP)		105	
Operating Temperature		T_A	-40 ~ +85	$^\circ\text{C}$
Storage Temperature		T_{stg}	-40 ~ +85	
Lead Solder Temperature [2mm Below Package Base]	260 $^\circ\text{C}$ For 5 Seconds			

Operating Characteristics (TA=25°C)			UG (GaP)	Unit
Forward Voltage (Typ.) (IF=10mA)	C,D,G,H,K,M,N,S,R,T	VF	4.0	V
	A,B,E,F,P,U(DP)		2.0	
Forward Voltage (Max.) (IF=10mA)	C,D,G,H,K,M,N,S,R,T	VF	5.0	V
	A,B,E,F,P,U(DP)		2.5	
Reverse Current (VR=10V(5V))	C,D,G,H,K,M,N,S,R,T	IR	10	uA
	A,B,E,F,P,U(DP)			
Wavelength of Peak Emission (IF=10mA)		λ_p	565	nm
Wavelength of Dominant Emission (IF=10mA)		λ_D	568	nm
Spectral Line Full Width At Half-Maximum (IF=10mA)		$\Delta\lambda$	30	nm
Capacitance (VF=0V, f=1MHz)		C	15	pF

Part Number	Emitting Color	Emitting Material	Luminous Intensity (IF=10mA)		Wavelength nm λ_P	Description
			min.	typ.		
XAUG30A	Green	GaP	3000	11990	565	Common Anode, Rt. Hand Decimal



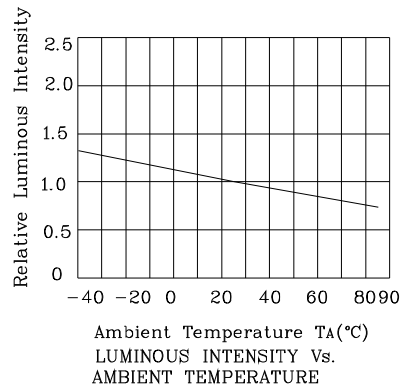
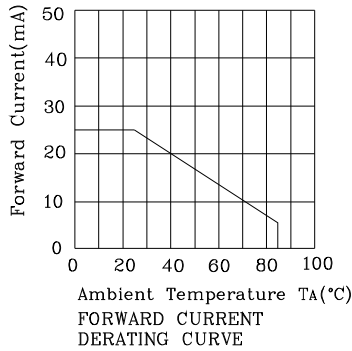
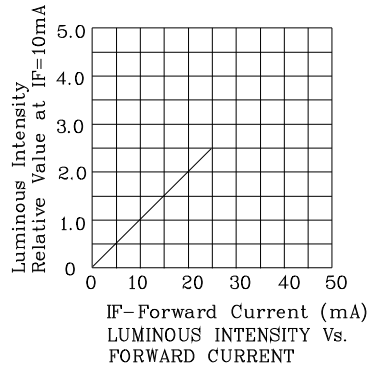
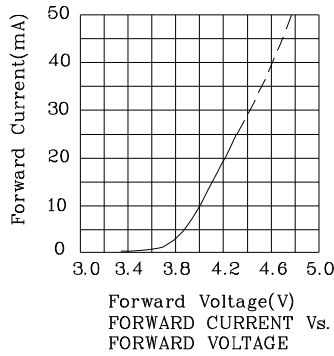
Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

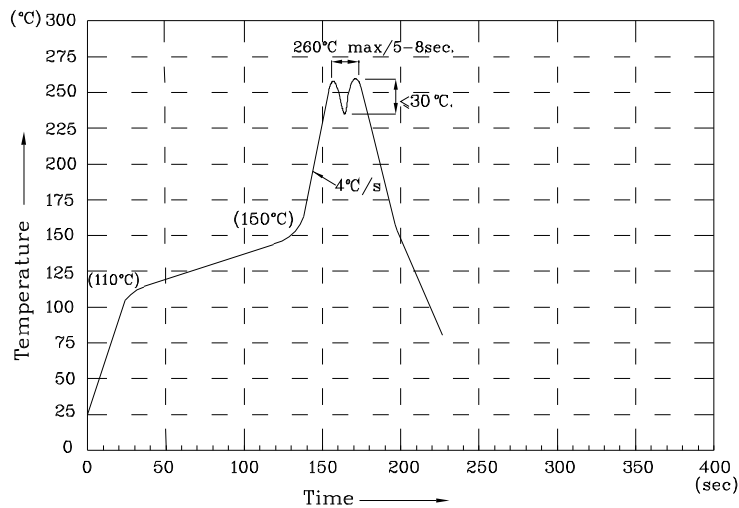
Note: Accuracy may depend on the sorting parameters.

❖ UG



XAUG30A

Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.